









About the project

Innovative multifunctional material concept for electronic applications project Coco aims to print parts with embedded electrical infrastructure for power electronics. Therefore, an innovative material concept combining copper as highly conductive material and glass as high temperature isolator is developed. Printed in an extrusion based process, manufacturing of multimaterial parts with high-throughput, energy and material efficiency is hoped to be achieved. Existing electronic devices based on plastic substrates should be improved with more versatility, added functionality, and an increased working temperature range.

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